

INDUSTRIAL PCB DESIGNING INTERNSHIP

MEA IEDC recently conducted a one-day internship programme on 25th of July '19. The internship was based on the topic Industrial PCB Designing and was conducted in association with OSPERB INNOVATIONS, a start-up-based company which sprouted from the MEA IEDC start-ups list and have



currently proven to be superior in terms of electronic product designing, development and manufacturing. They have trained over 30 btech students across various streams (ECE, EEE, ME, CS).

S tudents from various colleges like Vidya Academy, Ammini Engg. College,



Munnar Engg. College to name a few, have attended this internship. The internship has incorporated the following 10 Core topics- Electronic Components, Circuit Design Techniques, Autodesk Eagle Software, Schematics and Footprint, Single Layer PCB Design, Multi-Layer PCB Design, SMD PCB Design, PCB Structural Design, CAM Data Processing, and PCB

Manufacturing Procedures.

The students were immensely interactive and the internship was therefore efficient and efficacious in a way that encouraged the students to complete the training by noon. The session hence proved to be beneficial for the delegates present for the programme. The day concluded by a photo session and vote of thanks.

